

Highly stretchable and conformable conductors for on-skin multimodal sensing

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Motivation

- **Multimodal on-skin monitoring of physiological signals**
 - Applications in healthcare, human-machine interfacing, robotics, and prostheses
 - Easy-to-apply, stretchable and skin-conforming sensor networks
- **State of the art sensors**
 - Consumable sensors: limited signal quality, not medically certified
 - Medical sensors: single use or expensive; inefficient production
 - Lithography microfabrication, electrode sputtering or chemical
- **We propose**
 - intelligent stretchable conductors exhibiting **tunable electrical conductivities** and **surface morphologies**
 - considerably increased **material and energy efficient** production
 - reusable, multimodal sensing
 - using **one sensor for multiple bio-signal** acquisition tasks

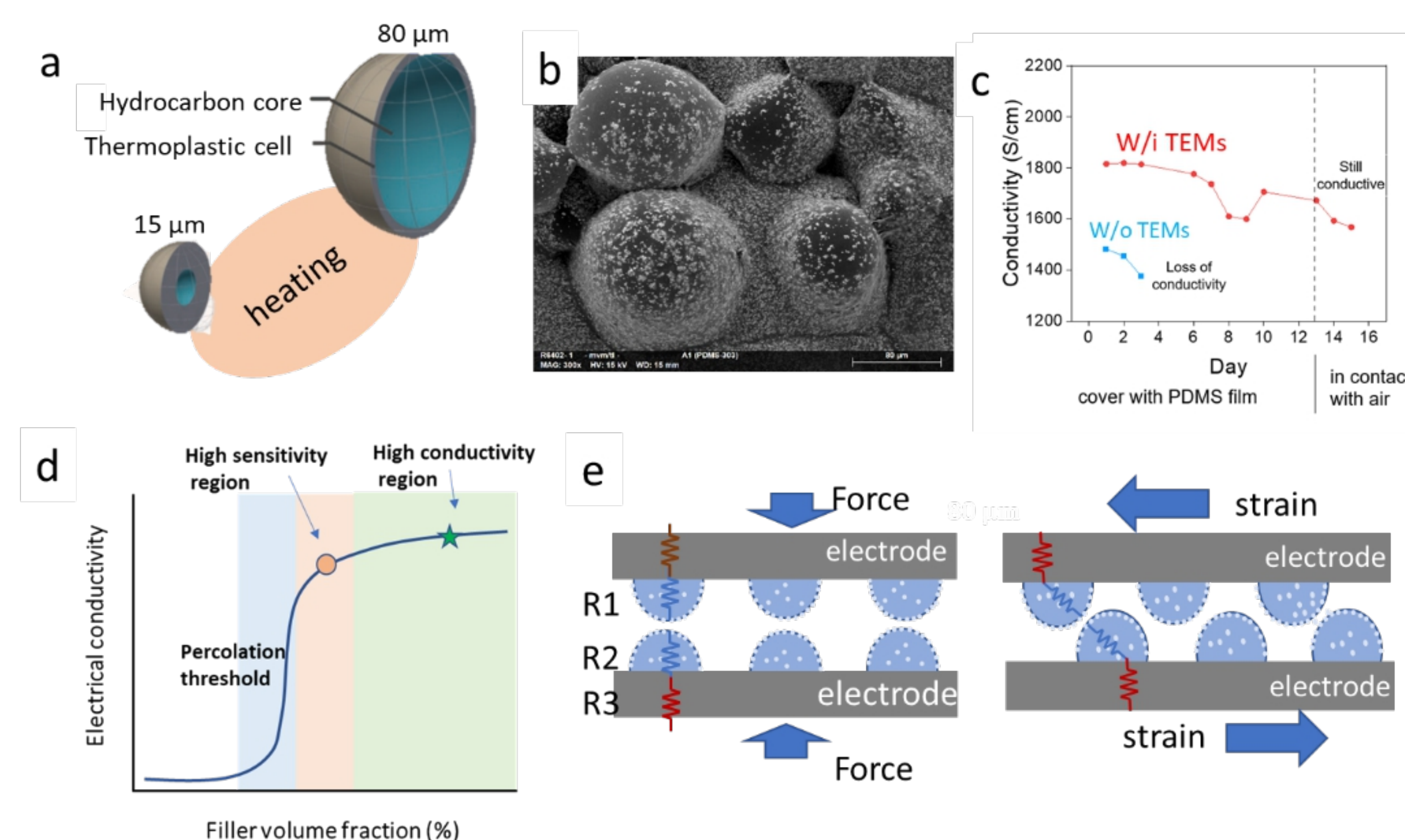


Figure 1: a) mechanism of TEMs. b) SEM of TEMs in Ag-PDMS. c) comparison of electrical conductivities between Ag-PDMS with TEMs and without TEMs. d) sensitive region and high conductive region in percolation map. e) hierarchical design of multimodal sensors.

Aims

- **1) Develop 2 types of stretchable and conformable Ag-PDMS leveraging thermable expandable microspheres (TEMs)**
 - Type A: **highly conductive** for dry electrodes (electrophysiology) high filler region (star sign in Figure 1d)
 - Type B: **highly sensitive** for pressure / strain sensing (blood pressure, respiration effort above percolation threshold (sphere sign in Figure 1d))
- **2) Prototyping biosignal sensors for the 2 Ag-PDMS materials**
 - Multimodal sensors with **hierarchical 3D semi-dome structure** (Figure 1e)
 - Exposed dome: electrophysiology (EEG, ECG, EMG) sensor + hierarchical semi-dome: responsive to pressure / strain (respiration effort)
- **3) On-skin testing, validation and multimodal data decomposition**
 - Sensor **evaluation in real-world** conditions (reliability, accuracy, long-term use)
 - Sensor optimization (shape and mechanical conformability)
 - Proof-of-principle **decomposition of multimodal bio-signals**

Green electronics

„Energy-efficient computing“ + „Intelligent Materials“

- **1) Relevance & thematic coverage**
 - **Material & energy saving** (production, multimodal)
 - **Long-time stable & reusable** intelligent materials
 - **Energy-efficient** multimodal **signal computing**
- **2) Scientific excellence**
 - **Novel concept of adopting microspheres** to tune the conductor morphology
 - **Hierarchical** structural design
 - Multimodal **mechanical and electrical sensing**
- **3) Strategic perspective**
 - Initial project with planned **follow-up DFG proposal**
 - **Transfer projects** with medical industry
 - Potential for **multiple technology patents**

Work packages and interdisciplinary approach

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Material science, chemical + mechanical + electrical characterization, prototyping and production considerations

WP1: Ink Formulation & Characterization

- Material selection and characterization
- Capillary suspension concept
- Ag and PDMS parameter optimization
- TEM concentration effect investigation

Year 1-2

WP2: Sensor prototyping

- 3D additive manufacturing
- Hierarchical foamy structure
- Self-adhesive stretchable circuits
- Lab tests and optimization

Year 2-3

WP3: On-skin testing and signal processing

- Validation and signal characterization
- Physical phantoms + on-skin testing
- Motion and long-term applicability
- Multimodal signal decomposition

Year 3-4

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Application requirements, medical characteristics and durability, signal quality assessment, validation and signal processing

Prior work and references

- [1] Q. Hua, J. Sun, H. Liu, R. Bao, R. Yu, J. Zhai, C. Pan, Z. L. Wang, Nature communications 2018, 9, 244
- [2] M. S. Rodrigues, P. Fiedler, N. Küchler, R. P. Domingues, C. Lopes, J. Borges, J. Haueisen, F. Vaz, Materials 2020, 13, 2135
- [3] A. R. Mota, L. Duarte, D. Rodrigues, A. Martins, A. Machado, F. Vaz, P. Fiedler, J. Haueisen, J. Nóbrega, C. Fonseca, Sensors and Actuators A: Physical 2013, 199, 310
- [4] B. Vasconcelos, P. Fiedler, R. Machts, J. Haueisen, C. Fonseca, Frontiers in neuroscience 2021, 15, 748100
- [5] I. H. Mulyadi, P. Fiedler, R. Eichardt, J. Haueisen, E. Supriyanto, Medical & Biological Engineering & Computing 2021, 59, 431
- [6] H. Sun, Z. Han, N. Willenbacher, ACS applied materials & interfaces 2019, 11, 38092
- [7] A. Hunold, D. Strohmeier, P. Fiedler, J. Haueisen, Biomedical Engineering/Biomedizinische Technik 2018, 63, 683